

## Technical Data Sheet

### 1.9mm Round Subminiature Lead LEDs

#### 95-21USOC/S530-XX/XXX

#### Features

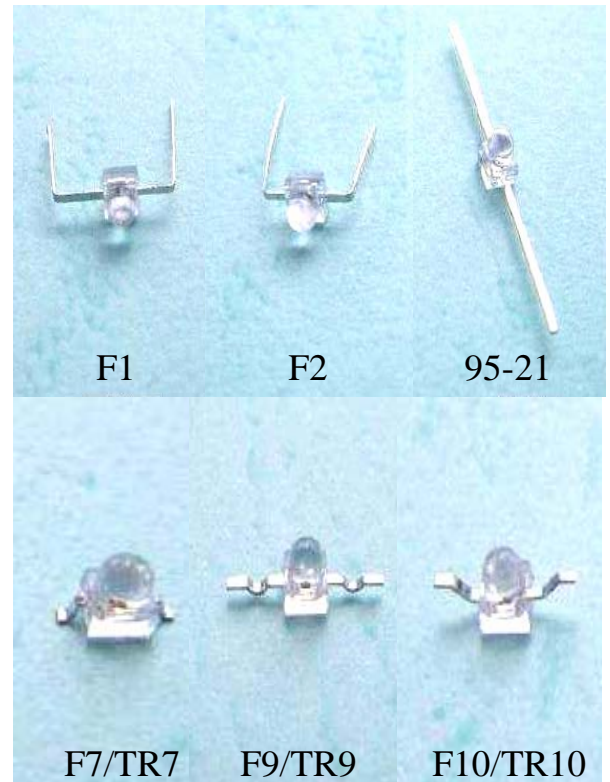
- Package in 12mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free
- The product itself will remain within RoHS compliant version.

#### Descriptions

- The 95-21 SMD taping is much smaller than leaded components . Thus enable smaller board size. Higher packing density. Reduced storage space and finally smaller equipment to be obtained.
- Besides, light weight makes them ideal for miniature applications.
- Furthermore by automation assembly machines the accuracy is anticipated.

#### Applications

- Small indicator for indoor applications.
- Flat backlight for LCD, switches and symbols.
- Indicator and backlight in office equipment.
- Indicator and backlight for battery driven equipment.
- Indicator and backlight for audio and video equipment.
- Telecommunication : indicator and backlighting in telephone and fax.

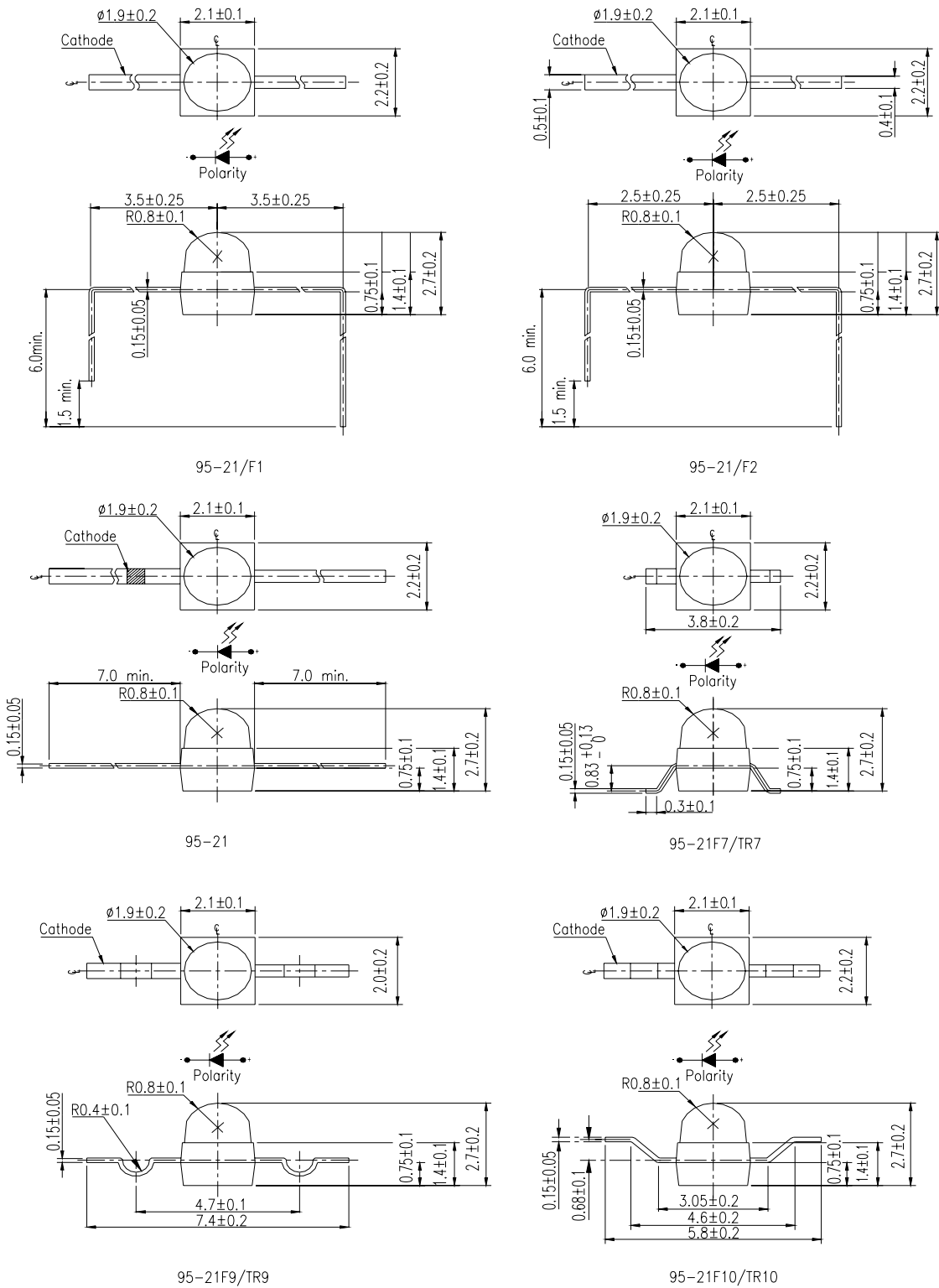


#### Device Selection Guide

Part No.	Chip		Lens Color
	Material	Emitted Color	
95-21USOC/S530-A3/XXX	AlGaInP	Reddish Orange	Water Clear

**95-21USOC/S530-XX/XXX**

**Package Dimensions**



**95-21USOC/S530-XX/XXX**

**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	25	mA
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C
Electrostatic Discharge(HBM)	ESD	2000	V
Power Dissipation	P <sub>d</sub>	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	60	mA
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 260°C for 10sec. Hand Soldering : 350°C for 3 sec.	

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Rank	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	IV	A2	198	529	----	mcd	I <sub>F</sub> =20mA
		A3	463	714	----	mcd	I <sub>F</sub> =20mA
		A4	661	892	----	mcd	I <sub>F</sub> =20mA
		A5	793	1156	----	mcd	I <sub>F</sub> =20mA
		A6	991	1454	----	mcd	I <sub>F</sub> =20mA
Viewing Angle	2θ 1/2	----	----	25	----	deg	I <sub>F</sub> =20mA
Peak Wavelength	λ <sub>p</sub>	----	----	621	----	nm	
Dominant Wavelength	λ <sub>d</sub>	----	----	615	----	nm	
Spectrum Radiation Bandwidth	Δλ	----	----	18	----	nm	
Forward Voltage	V <sub>F</sub>	----	----	2.0	2.4	V	
Reverse Current	I <sub>R</sub>	----	----	----	10	μA	V <sub>R</sub> =5V

\*95-21USOC/S530-XX / XXX

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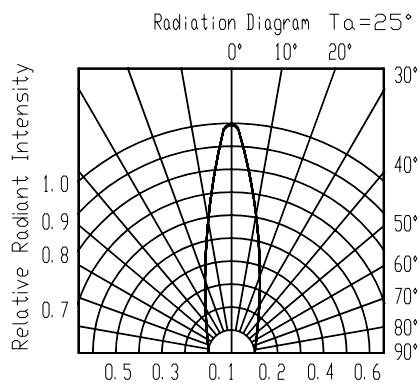
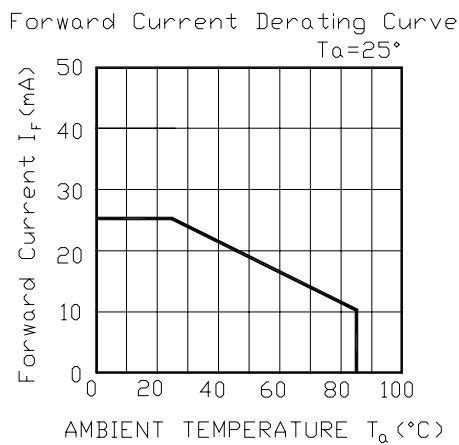
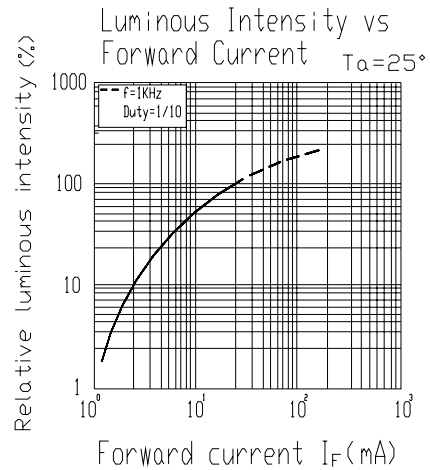
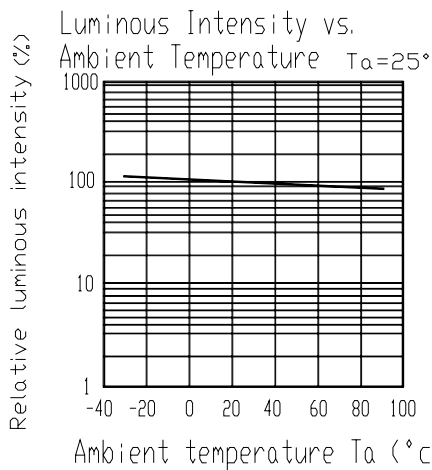
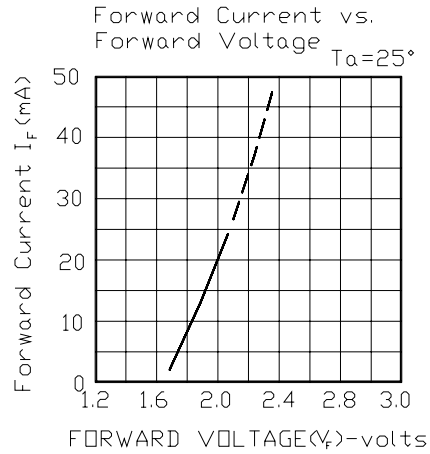
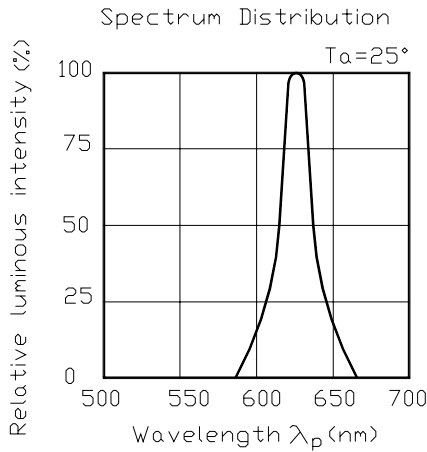
1:Chip Rank

2:Packing Method:

(1) None,F1,F2, F7,F9,F10 : Bulk

(2) TR7,TR9,TR10 : Taping

**Typical Electro-Optical Characteristics Curves**

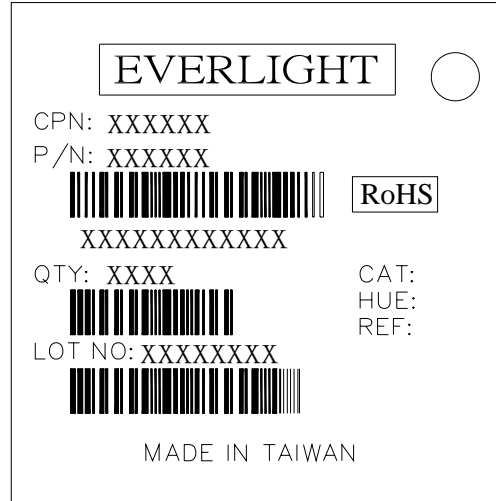


**Label explanation**

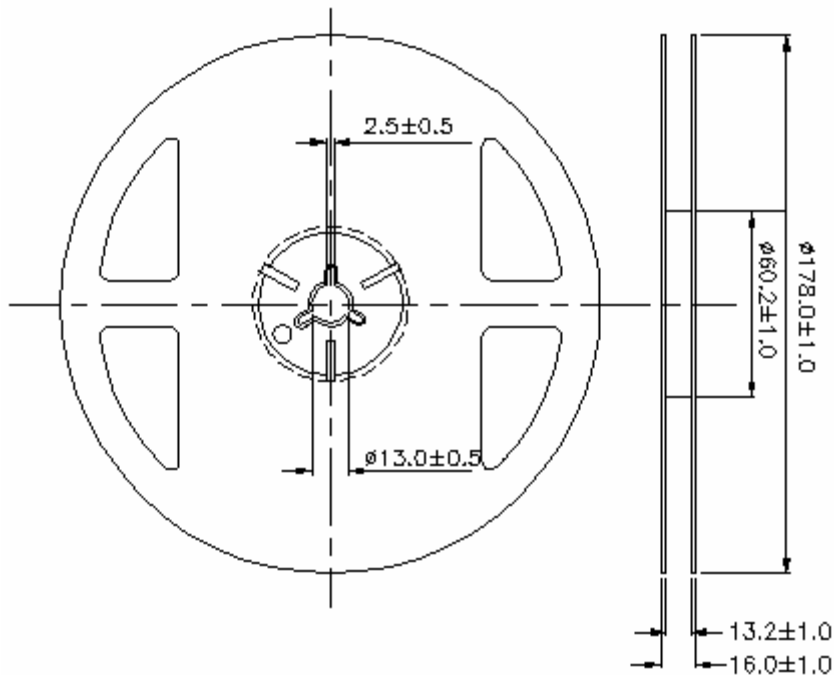
**CAT: Luminous Intensity Rank**

**HUE: Dom. Wavelength Rank**

**REF: Forward Voltage Rank**



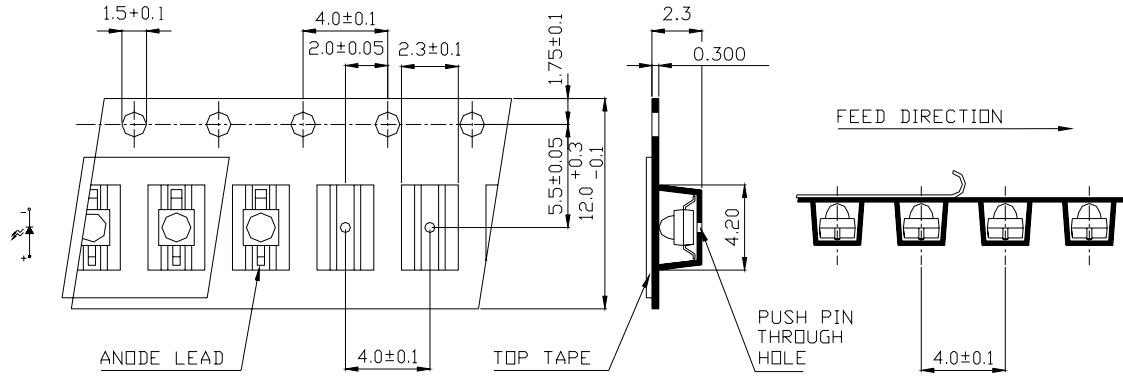
**Reel & Carrier Tape Dimensions**



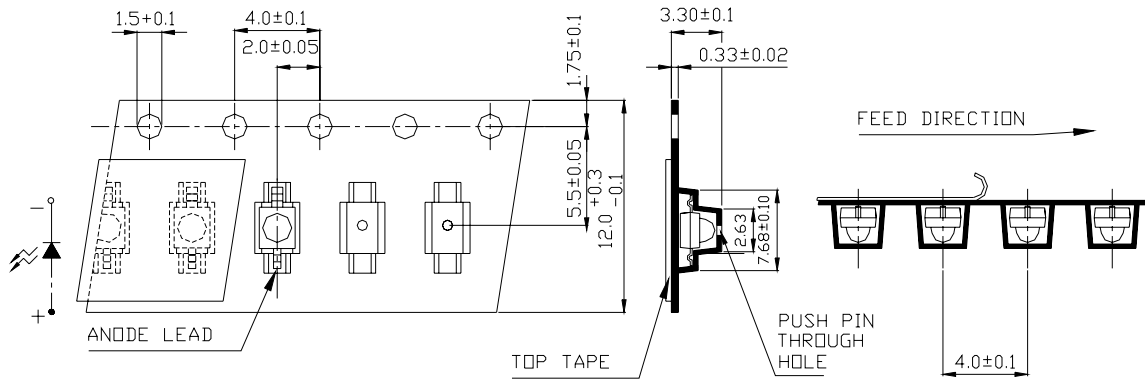
Note: The tolerances unless mentioned are  $\pm 0.1$ , unit=mm.

**95-21USOC/S530-XX/XXX**

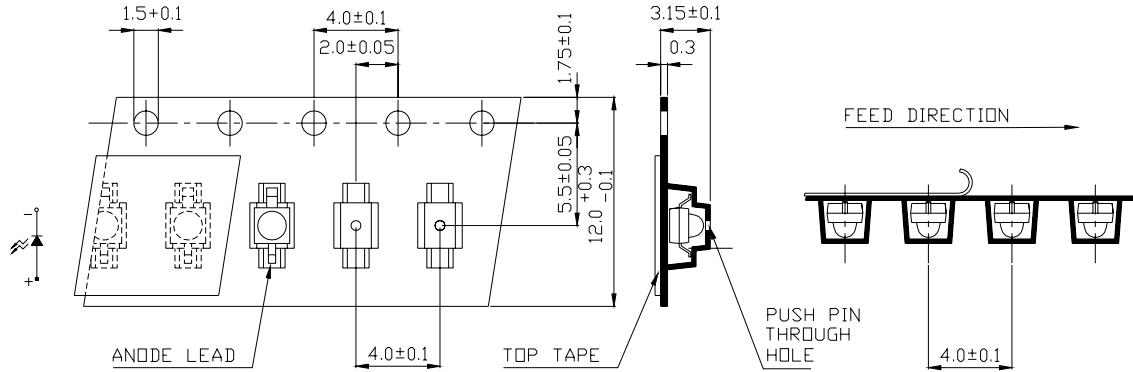
Loaded quantity 1000 PCS per reel



95-21/TR7



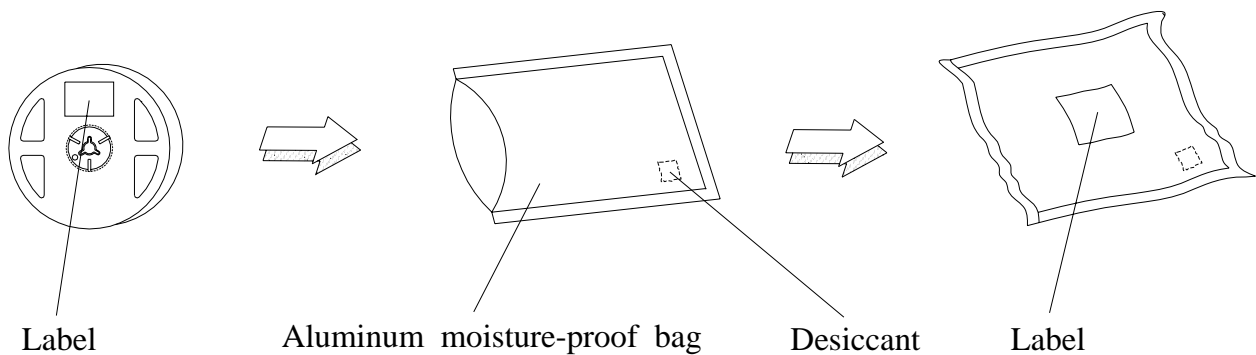
95-21/TR9



95-21/TR10

**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  ,Unit = mm

**Moisture Resistant Packaging**



**Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Reflow	Temp. : 240°C±5°C Min. 5 sec.	6 min.	22 PCS.	0/1
2	Temperature Cycle	H : +85°C 30min § 5 min L : -55°C 30min	50 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min § 10 sec L : -10°C 5min	50 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -55°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/RH85%	1000 Hrs.	22 PCS.	0/1



**Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less(Floor life).

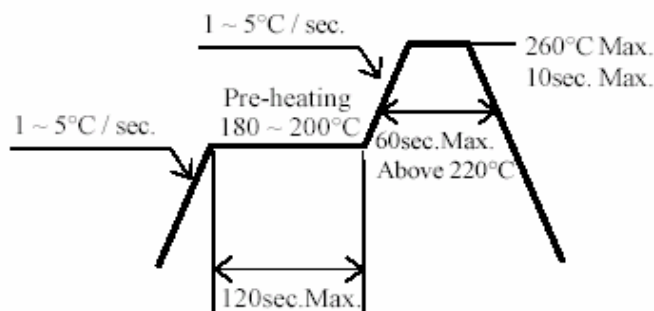
However,it's recommended that The LEDs should be used within 168 hours (7 days) after opening the package.If unused LED remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

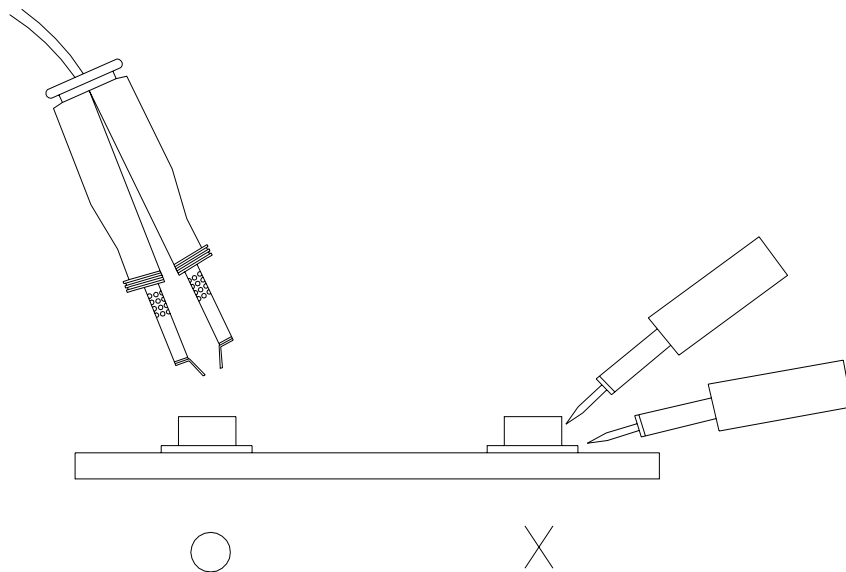
3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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